

Program Schedule

The 33rd Sensor Symposium
The 8th Symposium on Integrated MEMS Technology
Japan and Taiwan International Exchange Symposium

	Venue		Hirado Bunka Center Hall (1F)	Hirado Bunka Center Hall (2F)	Hirado Bunka Center Room C (1F)	Hirado Bunka Center Room (1F)	Mirai Sozokan Hall (1F)	Hirado Bunka Center Hall (1F) & Foyer	Hirado Kaijo Hotel		
	Venue Code		A	B	C	D	E	P	W		
Sunday, Oct. 23		17:30-19:30							Pre-conference Reception		
Monday, Oct. 24	AM1	09:00-09:30	Opening Ceremony					Poster Session	Exhibits Hour		
		09:30-10:10	Keynote Speech Akira Takata A and Live, Inc.								
		10:10-10:15	Introduction of Exhibits								
		Break									
	AM2	10:20-11:50	Packaging Technology for Sensor and MEMS (collaborated with The Japan Institute of Electronics Packaging)	Micro-nano Process/Materials Technology I	System Application	MEMS/NEMS (General)	Symposium on Integrated MEMS Technology: Device Materials and Circuits				
	Lunch Time	11:50-13:15	Exhibitors' Presentation								
	PM1	13:15-13:20	Japan and Taiwan International Exchange Symposium Opening Remarks								
		13:20-14:00	Keynote Speech Prof. Weileun Fang National Tsing Hua University								
		Break									
	PM2	14:05-16:05	Japan and Taiwan International Exchange Symposium	Micro-nano Process/Materials Technology II	Sensor/Actuator Systems	Meta-material/Plasmonic Structure	IEEJ/JSME Collaborative Organized Session I				
		Break									
	PM3	16:15-18:15		Biological & Environmental Sensing	Bio Sensor	Chemical Sensor I	IEEJ/JSME Collaborative Organized Session II				
	Break										
		19:00-21:00							Conference Reception		
Tuesday, Oct. 25	AM1	09:00-09:40	Keynote Speech Prof. Kiyoshi Toko Kyushu Univ.					Poster Session	Exhibits Hour		
		09:40-10:20	Keynote Speech Prof. Chris Van Hoof imec								
		移動5分									
	AM2	10:25-12:25	Exhibitors' Presentation							Presentation of Poster Session I	
	Lunch Time	12:25-13:40									
	PM1	13:40-13:45	Public Session Opening Remarks								
		13:45-14:25	Keynote Speech Satoshi Kuribayashi Kuribayashi Natural Science Photo Institute								
		Break									
	PM2	14:30-15:30	Public Session Seas, Mountain, Sky and Sensors	Special Session organized by Institute of Electronics, Information and Communication Engineers (IEICE) I	MEMS/NEMS & Energy Harvester	Symposium on Integrated MEMS Technology: Packaging				Poster Session	
		Break									
	PM3	15:40-16:40		Special Session organized by Institute of Electronics, Information and Communication Engineers (IEICE) II	Bio MEMS I	Symposium on Integrated MEMS Technology: Energy/Bio Devices					
		Break									
PM4	16:45-18:45	Exhibitors' Presentation					Presentation of Poster Session II				
	Break										
		19:30-21:30							Authors' Interviews for Freshmen		
Wednesday, Oct. 26	AM1	08:30-10:00	Chemical Sensor II	Physical Sensor	Bio MEMS II	Symposium on Integrated MEMS Technology: MEMS		Exhibits Hour			
		Break									
	AM2	10:10-10:50	Keynote Speech Prof. Yoshihiro Miyake Tokyo Institute of Technology								
10:50-11:20		Closing Remarks & Award Ceremony									